

ES1AF THRU ES1JF

Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case:SMAF
- Terminals: Solderable per MIL-STD-750, Method2026
- Approx.Weight: 27mg / 0.00095oz



Simplified outline SMAF and symbol

Pinning

PIN	DESCRIPTION
1	Cathode
2	Anode

Absolute Maximum Ratings And Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	ES1AF	ES1BF	ES1CF	ES1DF	ES1EF	ES1GF	ES1JF	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current	I _{F(AV)}				1				A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}				30				A
Maximum Forward Voltage at 1 A	V _F		1.0			1.25		1.68	V
Maximum DC Reverse Current Ta = 25° C at Rated DC Blocking Voltage Ta =125° C	I _R			5					µA
				100					
Typical Junction Capacitance at VR=4V, f=1MHz	C _J			15					pF
Maximum Reverse Recovery Time ⁽¹⁾	t _{rr}			35					ns
Typical Thermal Resistance ⁽²⁾	R _{θJA}			80					°C/W
Operating and Storage Temperature Range	T _j , T _{stg}			-55 ~ +150					°C

(1) Measured with IF = 0.5 A, IR = 1 A, Irr = 0.25 A

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas

Rating And Characteristic Curves

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram

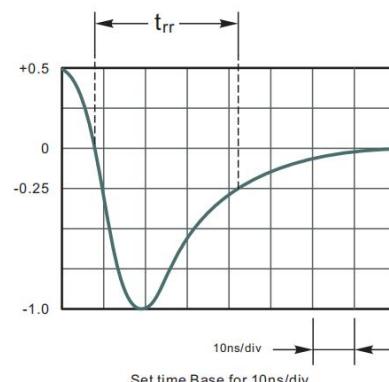
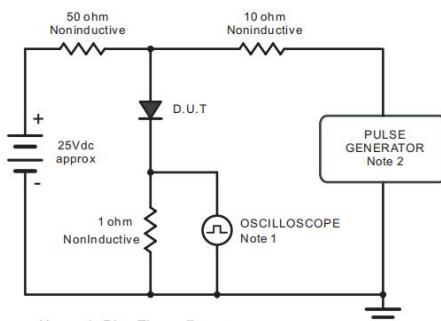


Fig.2 Maximum Average Forward Current Rating

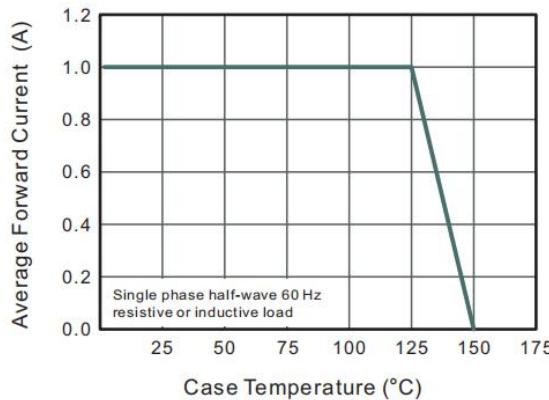


Fig.3 Typical Reverse Characteristics

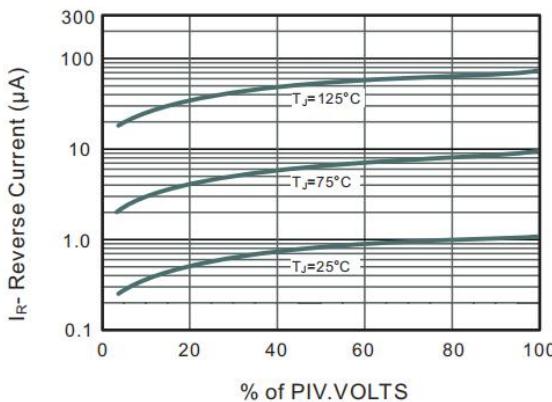


Fig.4 Typical Forward Characteristics

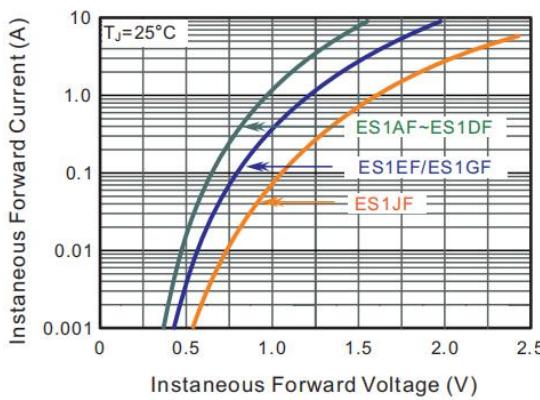


Fig.5 Typical Junction Capacitance

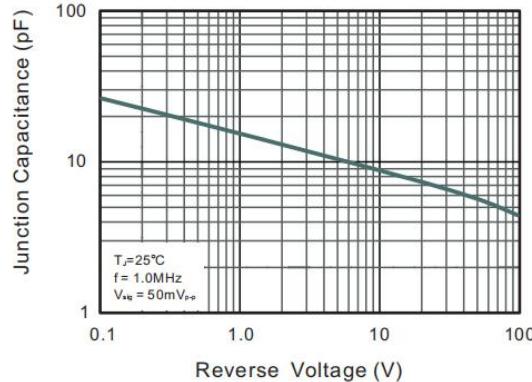
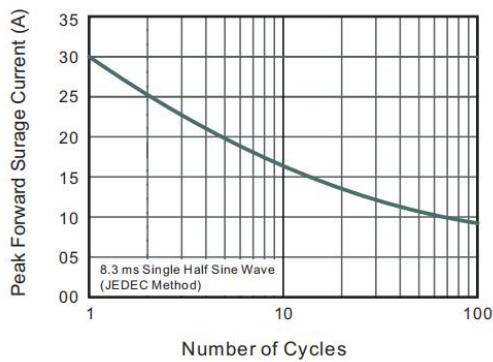


Fig.6 Maximum Non-Repetitive Peak

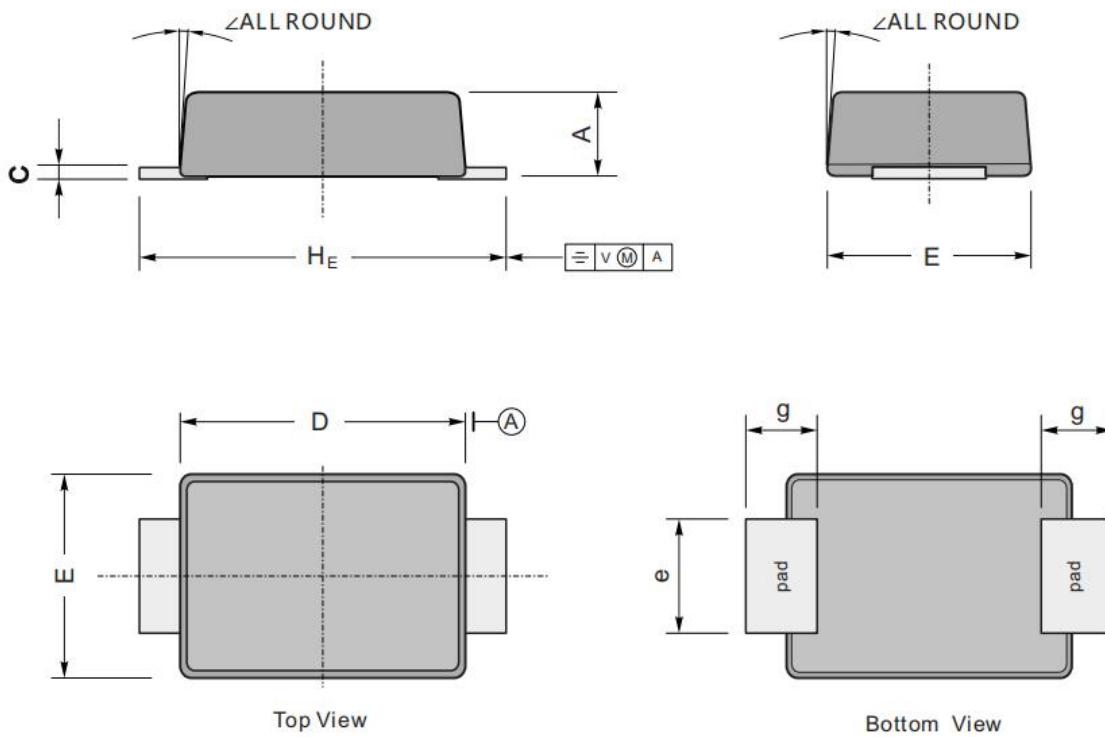
Forward Surge Current



Package Outline

Plastic surface mounted package; 2 leads

SMAF



UNIT		A	C	D	E	e	g	H _E	\angle
mm	max	1.2	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	47	7.9	146	106	63	47	193	7°
	min	35	4.7	130	94	51	31	173	

The recommended mounting pad size

